#### **APPLICATIONS**

Case: SOT-23

**MECHANICAL DATA** 

Switching mode power supply (SMPS)

•	Meet JESD 201 class 1A whisker test
•	Weight: $8\pm$ 0.5 mg (approximately)

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER	SYMBOL	BAW56	BAV70	BAV99	UNIT	
Marking code on the de	vice		A1	A4	A7	
Power dissipation		PD	225			mW
Repetitive peak reverse voltage		V <sub>RRM</sub>	70			V
Repetitive peak forward current		I <sub>FRM</sub>	450		mA	
Forward current		I <sub>F</sub>	200		mA	
Non-Repetitive peak	@ t = 1s	0.5				
forward surge current	@ t = 1µs	FSM	2			A
Junction temperature range		TJ	-55 to +150		°C	
Storage temperature range		T <sub>STG</sub>	-55 to +150			°C



**KEY PARAMETERS** 

VALUE

200

70

2

1.25

150

SOT-23

UNIT

mΑ

V

А

V

°C

# 200mA, 70V SMD Switching Diode

- Fast switching speed
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020

 Molding compound meets UL 94 V-0 flammability rating • Terminal: Matte tin plated leads, solderable per J-STD-002

- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

SEMICONDUCTOR

TAIWAN

#### **BAW56, BAV70, BAV99** Taiwan Semiconductor

PARAMETER

 $I_{F}$ 

V<sub>RRM</sub>

 $I_{FSM}$ 

V<sub>F</sub> at I<sub>F</sub>=150mA

 $\mathsf{T}_{\mathsf{J}\,\mathsf{MAX}}$ 

Package



THERMAL PERFORMANCE					
PARAMETER	SYMBOL	ТҮР	UNIT		
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	556	°C/W		

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	MIN	MAX	UNIT
Forward voltage per diode <sup>(1)</sup>		I <sub>F</sub> = 50mA, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.00	N
		I <sub>F</sub> = 150mA, T <sub>J</sub> = 25°C			1.25	V
Reverse voltage		I <sub>R</sub> = 100 μA, T <sub>J</sub> = 25°C	V <sub>R</sub>	70	-	V
Reverse current @ rated $V_R$ per diode <sup>(2)</sup>		V <sub>R</sub> = 70 V, T <sub>J</sub> = 25°C	I <sub>R</sub>	-	2.5	μA
Junction	BAW56, BAV70		=1 MHz, V <sub>R</sub> =1V C <sub>J</sub>	-	2 pF	
capacitance	BAV99	T=1 MHZ, $V_R$ =1V		-		р⊢
Reverse recovery time		$I_F=I_R=10mA$ , R <sub>L</sub> = 100Ω, $I_{RR}=1mA$	t <sub>rr</sub>	-	6	ns

#### Notes:

1. Pulse test with PW=0.3 ms

2. Pulse test with PW=30 ms

ORDERING INFORMATION						
ORDERING CODE	PACKAGE	PACKING				
BAxxx RF	SOT-23	3K / 7" Reel				
BAxxx RFG	SOT-23	3K / 7" Reel				
BAxxx-B0 RF	SOT-23	3K / 7" Reel				
BAxxx-B0 RFG	SOT-23	3K / 7" Reel				
BAxxx-D0 RF	SOT-23	3K / 7" Reel				
BAxxx-D0 RFG	SOT-23	3K / 7" Reel				

Notes:

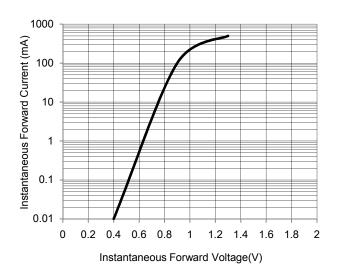
1. "xx" is device code from "W56" to "V99"

2. "G" means green compound (halogen free)



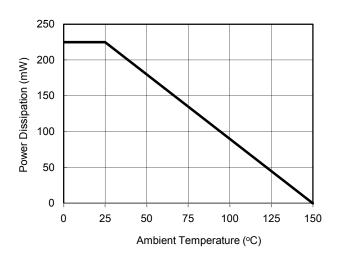
#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

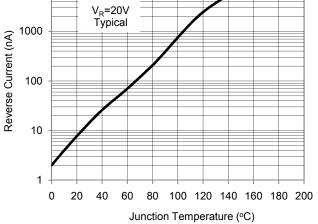


#### Fig.1 Typical Forward Characteristics





# 10000 V<sub>p</sub>=20V



#### Fig. 2 Reverse Current VS. Junction Temperature



# **BAW56, BAV70, BAV99**

Unit (mm)

Max.

1.12

0.50

0.20

3.04

2.64

1.40

1.90 BSC

0.54 REF.

Min.

0.89

0.30

0.08

2.80

2.10

1.20

DIM.

Α

b

С

D

Е

E1

е

L1

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Min.

0.035

0.012

0.003

0.110

0.083

0.047

Unit (inch)

Max.

0.044

0.020

0.008

0.120

0.104

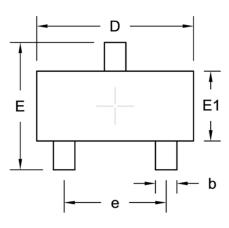
0.055

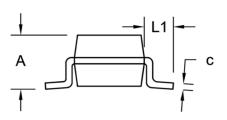
0.075 BSC

0.021 REF.

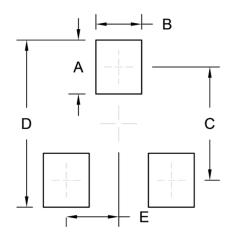
#### PACKAGE OUTLINE DIMENSION

**SOT-23** 



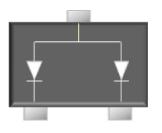


#### SUGGESTED PAD LAYOUT

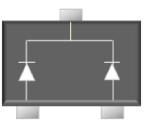


Symbol	Unit (mm)	Unit (inch)
А	1.00	0.039
В	0.85	0.033
С	2.10	0.083
D	3.10	0.122
E	0.98	0.039

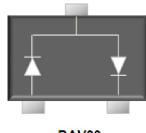
#### **PIN CONFIGURATION**



BAW56



BAV70







# **BAW56, BAV70, BAV99**

Taiwan Semiconductor

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